

NXP AN13454 Mifare Ultralight AES User Guide

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AN13454 MIFARE Ultralight AES quick start guide Rev. 1.1 — 18 February 2022 Application note COMPANY PUBLIC

Document information

Information	Content
Keywords	MIFARE, MIFARE Ultralight AES, quick start guide, AES Authentication, counter, CMAC
Abstract	This document gives a quick introduction to MIFARE Ultralight AES and lists all supporting d ocuments, software tools, and further material that is available and offered from NXP for an e asy product design-in. It summarizes all information required for somebody who wants to start solution development including MIFARE Ultralight AES.

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Revision history

Revision history

Rev	Date	Description
1.1	20220218	Security status changed to "Company public"
1	20211202	The initial version of this document

Introduction

1.1 Purpose of this document

This document introduces the MIFARE Ultralight AES technical support items and documentation and explains which deliverables can be retrieved from NXP to have a quick and smooth start with developing new MIFARE Ultralight AES applications, solutions, and infrastructures.

In this document, all the information that is necessary for somebody who is interested in MIFARE Ultralight AES is gathered. This bundle of information and support items that is provided is called the "Product Support Package" for the MIFARE Ultralight AES.

The Product Support Package is a full set of documentation and software deliverables, enabling system integrators, software engineers, card manufacturers, etc. to implement

their new solution based on MIFARE Ultralight AES is very easy and convenient.

1.2 Document audience

This document is targeting technical as well as marketing and business-oriented people who want to gather first knowledge concerning MIFARE Ultralight AES. Everybody who is interested in a more detailed and more technical level will be redirected to the full set of material complementing the IC.

It also addresses developers, project leaders, and system integrators who have a general technical understanding and overview of a specific smartcard technology or infrastructure. More in-depth details can be found in the complimentary application notes which are mentioned within this introductory document.

MIFARE Ultralight AES overview

2.1 Characteristics of MIFARE Ultralight AES

MIFARE Ultralight AES is the latest addition to the MIFARE Ultralight family, released in 2022.

The MIFARE Ultralight family has evolved since the first MIFARE Ultralight, and culminates with the MIFARE Ultralight AES being the first Common Criteria certified product in its family, providing AES-128 3-pass mutual authentication and memory access protection, and CMAC-based secure messaging for data integrity protection.

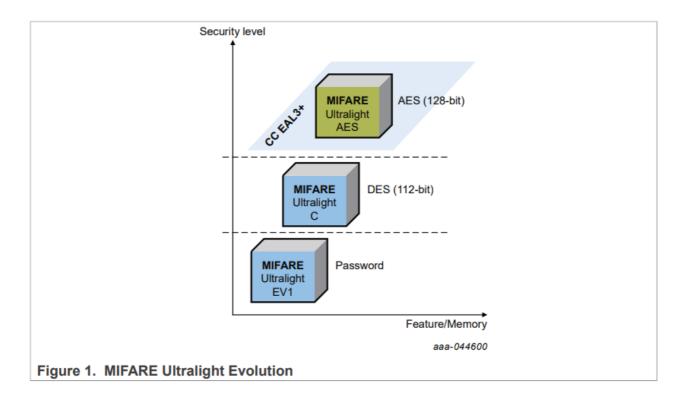


Table 1. MIFARE Ultralight AES feature comparison

Product features	MIFARE Ultralight				
Product leatures	EV1		С	AES	
RF Interface	ISO/IEC 14443-2, Type A 13.56		MHz		
Protocol	ISO/IEC 14443-3				
UID – unique identifier	7-byte UID				
Privacy				Random ID	
Communication speed	106 kbps				
Memory size [Bytes]	48	128	144	144	
Memory model					
Crypto			3KDES	AES	
Key length			112-bit	128-bit	
Authentication	Password		3-pass mutual		
Communication secur ity				СМАС	
Command Counter to limit negative authe ntication attempts	_			yes	

Table 1. MIFARE Ultralight AES feature comparison...continued

3x independent one- way counter	yes	_	yes (AES optional)
Virtual card concept			VC Select Last
Originality check feature s	ECC signature	_	ECC signature programmable
CC Certification			CC EAL 3+
NFC compliance	NFC Forum Type 2 Tag compliant		
Input capacitance [pF]	17 / 50		

2.2 MIFARE Ultralight AES key pillars

MIFARE Ultralight AES is the first limited-use MIFARE product on the market using Advanced Encryption Standard (AES) with external Common Criteria EAL3+ (AVA_VAN.2) security certification. It is targeted as a cost-effective solution for single-use public transport tickets, hospitality applications (such as hotel room access, parking garage access, spas, gyms etc.), and event ticketing.

Table 2. MIFARE Ultralight AES key features

Security	 Support of 3-pass mutual AES authentication based on a key length of 128-bit Data protection in user memory One-way counter with optional AES authentication protection Secure messaging communication mode (CMAC) for data integrity protection over RF-Interface Countermeasure against both replay attacks and man-in-middle attacks Common Criteria (CC) EAL3+ (AVA_VAN.2) certification
Privacy and ownership	 Random ID (optional) addressing privacy concerns to prevent personal data tracking Regulations do not allow to tracing end-user of a ticket outside authorized use cas e infrastructure Retrieval of 7-byte UNIQUE ID requires authentication with a dedicated 128-bit AE S key Originality Check based on customizable ECC signature
Design-in and scalabil ity	 AES support from ticket to card to phone Allows security streamlining from cost-effective single-use tickets up to multi-application product Silicon comes with DARK GREEN classification supporting eco-friendly paper ticket s and cards

The Product Support Package (PSP) for the MIFARE Ultralight AES is composed of the following deliverables:

- Datasheet DS5379 MIFARE Ultralight AES MF0AES(H)20 Product data sheet, available in NXP DocStore document number 5379xx
- Datasheet DS7036 MIFARE Ultralight AES MF0AES(H)30 Product data sheet, available in NXP DocStore document number 7036xx
- 3. Application note AN13454 MIFARE Ultralight AES quick start guide available in NXP DocStore, document number 7108xx
- 4. Application note AN13452 MIFARE Ultralight AES features and hints available in NXP DocStore, document number 7106xx
- Application note AN13453 MIFARE Ultralight AES card coil design guide available in NXP DocStore, document number 7107xx
- 6. Product qualification package QPP MIFARE Ultralight AES available in NXP DocStore, document number 7172xx
- 7. TapLinx An Android SDK offering easy implementation of Android Apps interacting with any of the NXPs offered contactless NFC-based ICs. Available via the NXP website under the following weblink: https://www.mifare.net/en/products/tools/taplinx/
- 8. RFID Discover A Windows-based software tool that can be used for NXP product-specific command exchange with the MIFARE Ultralight AES IC. Available in NXP DocStore and on the NXP website under the following weblinks:

https://www.nxp.com/search?category=softwaretools&keyword=rfiddiscover

https://www.mifare.net/en/products/tools/rfiddiscover/

- 9. NXP card test framework A Windows-based software tool that can be used for NXP product-specific command exchange with the MIFARE Ultralight AES IC. Especially suitable for generating transactions and scripts that can be used for chip configuration, personalization, transaction testing and much more. Available in NXP DocStore.
- 10. Android applications TagInfo and TagWriter Android Apps offer the possibility to interact with the MIFARE Ultralight AES smartcards, as well as any other of the NXPs, offered contactless NFC-based ICs. Available via the NXP Website under the following weblinks:

https://www.mifare.net/en/products/tools/nfc-taginfo-app/

https://www.mifare.net/en/products/tools/nfc-tagwriter-app/

11. MIFARE Ultralight AES sample cards can be requested directly at your NXP representative or contact person (sales, marketing, business development).

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Documents / Resources



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